

## AMENDMENT TRANSMITTAL LETTER (Large Entity)

Applicant(s):

MAY 24 2004

Docket No.

039-02

Serial No.  
10/079,864Filing Date  
February 21, 2002Examiner  
William D. ColemanGroup Art Unit  
7562

Invention: Insert-Moldable Heat Spreader, Semiconductor Device Using Same, And Method For Manufacturing Such Semiconductor Device

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

## CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	11 -	23 =	0	x \$18.00	\$0.00
INDEP. CLAIMS	4 -	5 =	0	x \$0.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

No additional fee is required for amendment.

Please charge Deposit Account No. in the amount of  
A duplicate copy of this sheet is enclosed.

A check in the amount of to cover the filing fee is enclosed.

The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 16-0750  
A duplicate copy of this sheet is enclosed.

Any additional filing fees required under 37 C.F.R. 1.16.

Any patent application processing fees under 37 CFR 1.17.



Signature

Dated: May 20, 2004

John F. McNulty, Esquire

Registration No. 23,028

Paul &amp; Paul

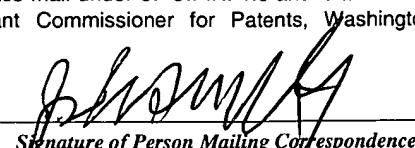
2900 Two Thousand Market Street

Philadelphia, Pa 19103

USA

(215) 568-4900

I certify that this document and fee is being deposited on May 20, 2004 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.



Signature of Person Mailing Correspondence

John F. McNulty, Esquire

Typed or Printed Name of Person Mailing Correspondence

CC:



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Serial No.: 10/079,864

Filed: February 21, 2002

Inventor: Masahiro Yonemochi

For: Insert-Moldable Heat Spreader, Semiconductor Device Using Same, and Method For Manufacturing Such Semiconductor Device

Examiner: William D. Coleman

Art Unit: 2811

Atty. Doc. No.: 039-02

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**AMENDMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Official Action dated February 19, 2004, please amend the claims of the application as indicated on the claim pages attached hereto.

With respect to the objection to the drawings, please note the proposed drawing corrections as indicated on the drawing pages provided herewith, and advise if the proposed corrections are acceptable, so that replacement formal drawings can be provided.

In view of the cancellation of various claims and the placement of previously objected-to claims in independent form, it is believed that all claims are now allowable.

An early Notice of Allowance is respectfully solicited.

Respectfully submitted,



John F. McNulty  
Reg. No. 23,028  
Paul & Paul  
2900 Two Thousand Market Street  
Philadelphia, PA 19103  
(215) 568-4900